

## Part Number: XSUYR47M

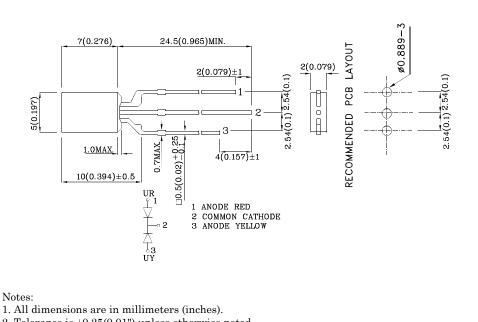
2x5mm BI-COLOR INDICATOR LAMP

### **Features**

- Radial / Through hole package
- Reliable & robust
- Low power consumption
- Available on tape and reel
- RoHS Compliant







Notes:

2. Tolerance is  $\pm 0.25(0.01")$  unless otherwise noted.

3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T <sub>A</sub> =25°C)		UR (GaAsP/ GaP)	UY (GaAsP/ GaP)	Unit		Operating (T <sub>A</sub> =25°C)	Characteristics		UR (GaAsP/ GaP)	UY (GaAsP/ GaP)	Unit
Reverse Voltage	V <sub>R</sub>	5	5	V		Forward Vol	tage (Typ.)	$V_{\rm F}$	2	2.1	v
Forward Current	$I_{\rm F}$	30	30	mA		(I <sub>F</sub> =20mA)					
Forward Current (Peak) 1/10 Duty Cycle	$i_{\rm FS}$	160	140	mA		Forward Vol (I <sub>F</sub> =20mA)	tage (Max.)	$V_{\mathrm{F}}$	2.5	2.5	v
0.1ms Pulse Width						Reverse Cur	rent (Max.)	$I_{R}$	10	10	uA
Power Dissipation	$\mathbf{P}_{\mathrm{D}}$	75	75	$\mathrm{mW}$		(V <sub>R</sub> =5V)	4.7. 1				
Operating Temperature	TA	A -40 ~ +85		°C		Wavelength of Peak Emission CIE127-2007* (Typ		) λP	627*	590*	nm
Storage Temperature	Tstg	-40 ~	- +85	-0		(I <sub>F</sub> =20mA)					
Lead Solder Temperature [2mm Below Package Base]	260°C For 3 Seconds					Wavelength of Dominant Emission CIE127-2007* (Typ.) (I <sub>F</sub> =20mA)		λD	617*	588*	nm
Lead Solder Temperature [5mm Below Package Base]						Spectral Line Full Width At Half-Maximum (Typ.) (I <sub>F</sub> =20mA)		$\bigtriangleup\lambda$	45	35	nm
						Capacitance (V <sub>F</sub> =0V, f=11	( ) 1 /	С	15	20	pF
Part Number		Emitting Emitting Color Material		L	Lens-color Luminous Intensi CIE127-2007* (I <sub>F</sub> =20mA) mcd			Waveleng CIE127-200 nm λP			
							min. ty	p.			
VOLUVD 4724		Red GaAsP/C		'GaP	White Diffused		8 1 4* 9	9 )*	627*		00
XSUYR47M		Yellow	GaAsP/GaP				4 6 4* 6	; ;*	590*	11	0°

\*Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

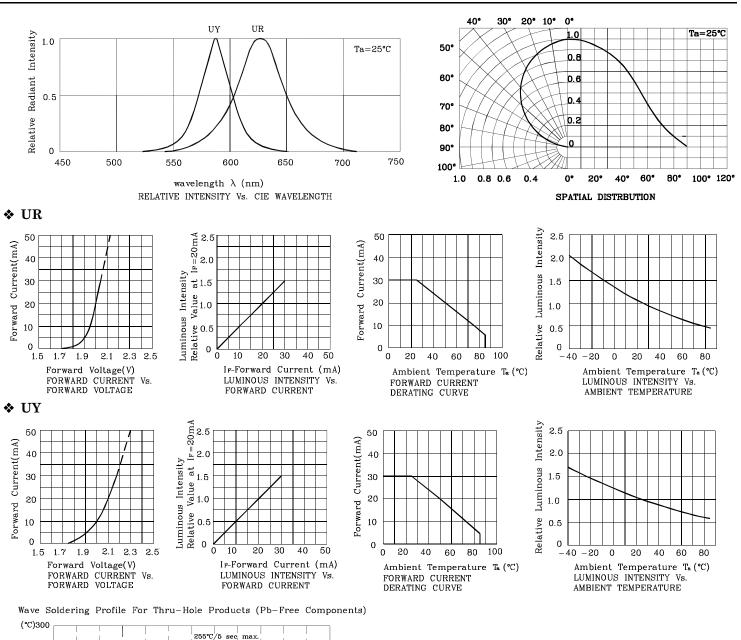
Dec 18,2013

XDSA2605 V8-X Layout: Maggie L.



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# Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity / luminous flux, or wavelength),

- the typical accuracy of the sorting process is as follows:
- 1. Wavelength: +/-1nm
- 2. Luminous Intensity / Luminous Flux: +/-15%
- 3. Forward Voltage: +/-0.1V
- Note: Accuracy may depend on the sorting parameters.

(a) See final).
(b) see final).
(c) apply stress to the epoxy resin while the temperature is above 85°C.
(c) Fixtures should not incur stress on the component when mounting and during soldering process.
(c) Constraints of the stress of t

4°C/s ma

Preheat

time:

N <30

(100°C)

60 sec max.

Time(sec)

Notes:
1. Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260°C
2. Peak wave soldering temperature between 245°C ~ 255°C for 3 sec
(5 gas max)

(5 sec max).

250

200

100 (8

50

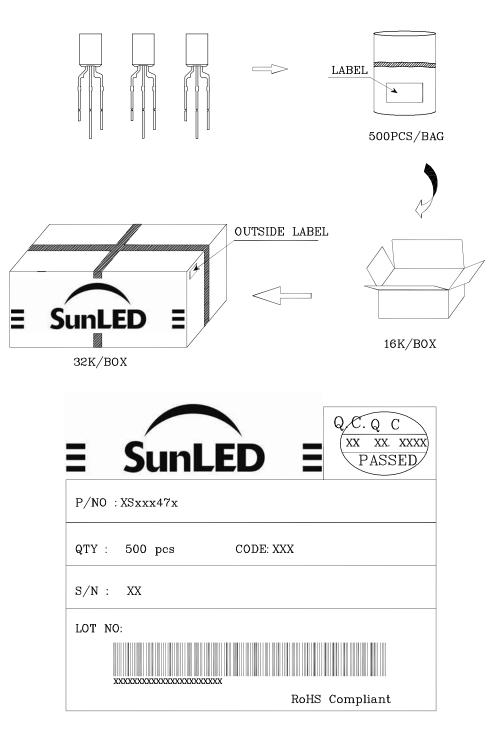
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Temperature 150

Notes:



### PACKING & LABEL SPECIFICATIONS



#### TERMS OF USE

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- 2. Contents within this document are subject to improvement and enhancement changes without notice.
- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet. User accepts full risk and responsibility when operating the product(s) beyond their intended specifications.
- 4. The product(s) described in this document are intended for electronic applications in which a person's life is not reliant upon the LED. Please consult with a SunLED representative for special applications where the LED may have a direct impact on a person's life.
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